

3A NPN Epitaxial Planar Power Transistor

TIP31CE3

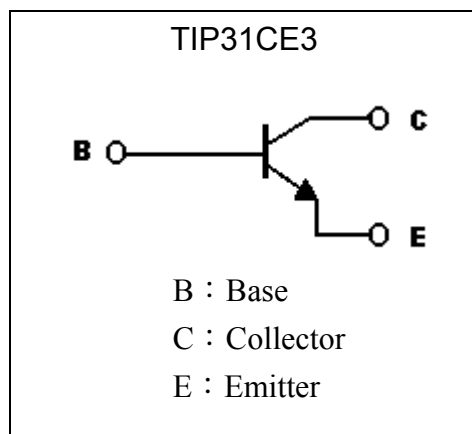
Description

TIP31CE3 is designed for use in general purpose amplifier and switching applications.

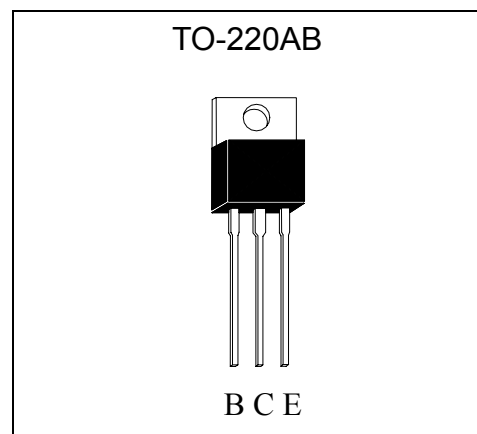
Features

- Low collector-emitter saturation voltage, $V_{CE(sat)} = 1.2V(max)$ @ $I_C = 3A$
- High collector-emitter sustaining voltage, $BV_{CEO(SUS)} = 100V(min)$
- High current gain-bandwidth product , $f_T = 3MHz(min)$ @ $I_C = 500mA$

Symbol



Outline



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-Base Voltage	V_{CBO}	100	V
Collector-Emitter Voltage	V_{CEO}	100	V
Emitter-Base Voltage	V_{EBO}	5	V
Collector Current (DC)	I_C	3	A
Collector Current (Pulse)	I_{CP}	5 (Note 1)	
Base Current	I_B	1	A
Power Dissipation @ Ta=25°C	P_D	2	W
Power Dissipation @ Tc=25°C	P_D	40	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.125	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	-55~+150	°C

Note : 1. Single Pulse , $P_w \leq 380\mu s$, Duty $\leq 2\%$.

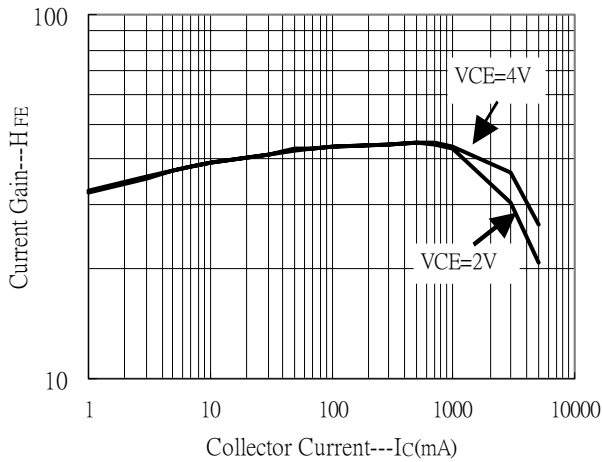
**Characteristics** (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
*BV _{CEO(SUS)}	100	-	-	V	I _C =30mA, I _B =0
I _{CEO}	-	-	300	μA	V _{CE} =60V, I _B =0
I _{CES}	-	-	200	μA	V _{CE} =100V, V _{BE} =0
I _{EBO}	-	-	1	mA	V _{EB} =5V, I _C =0
*V _{CE(sat)}	-	-	1.2	V	I _C =3A, I _B =375mA
*V _{BE(on)}	-	-	1.8	V	V _{CE} =4V, I _C =3A
*h _{FE}	25	-	-	-	V _{CE} =4V, I _C =1A
*h _{FE}	10	-	50	-	V _{CE} =4V, I _C =3A
f _T	3	-	-	MHz	V _{CE} =10V, I _C =500mA, f=1MHz

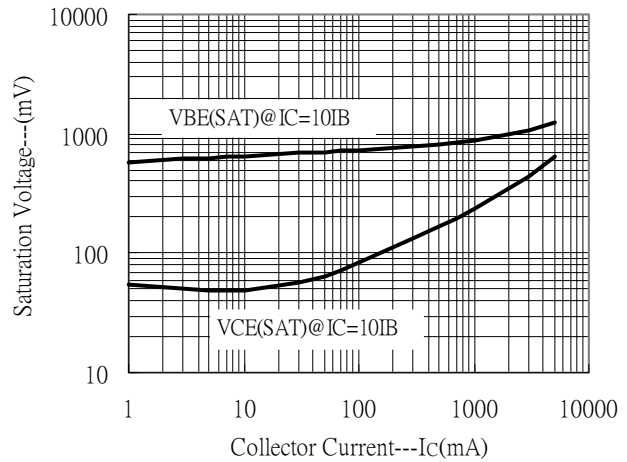
*Pulse Test : Pulse Width ≤380μs, Duty Cycle≤2%

Characteristic Curves

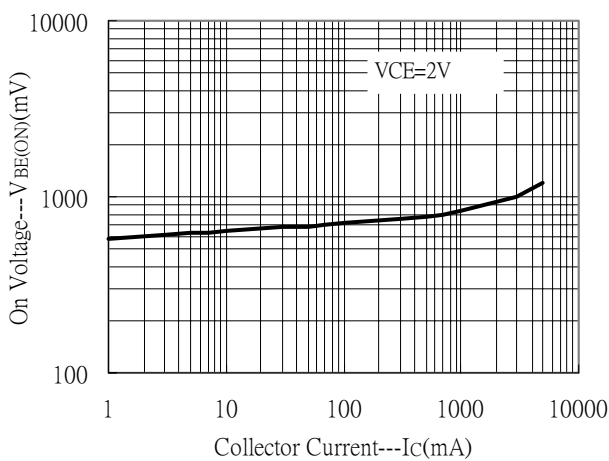
Current Gain vs Collector Current



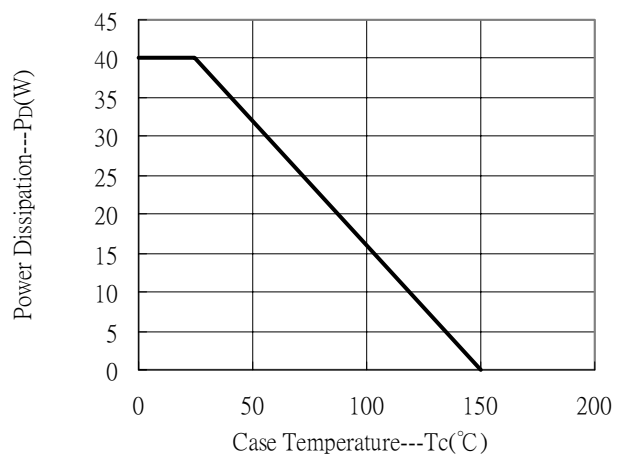
Saturation Voltage vs Collector Current



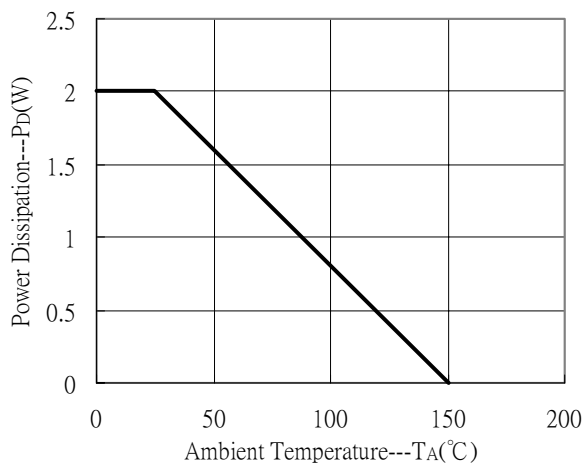
ON Voltage vs Collector Current



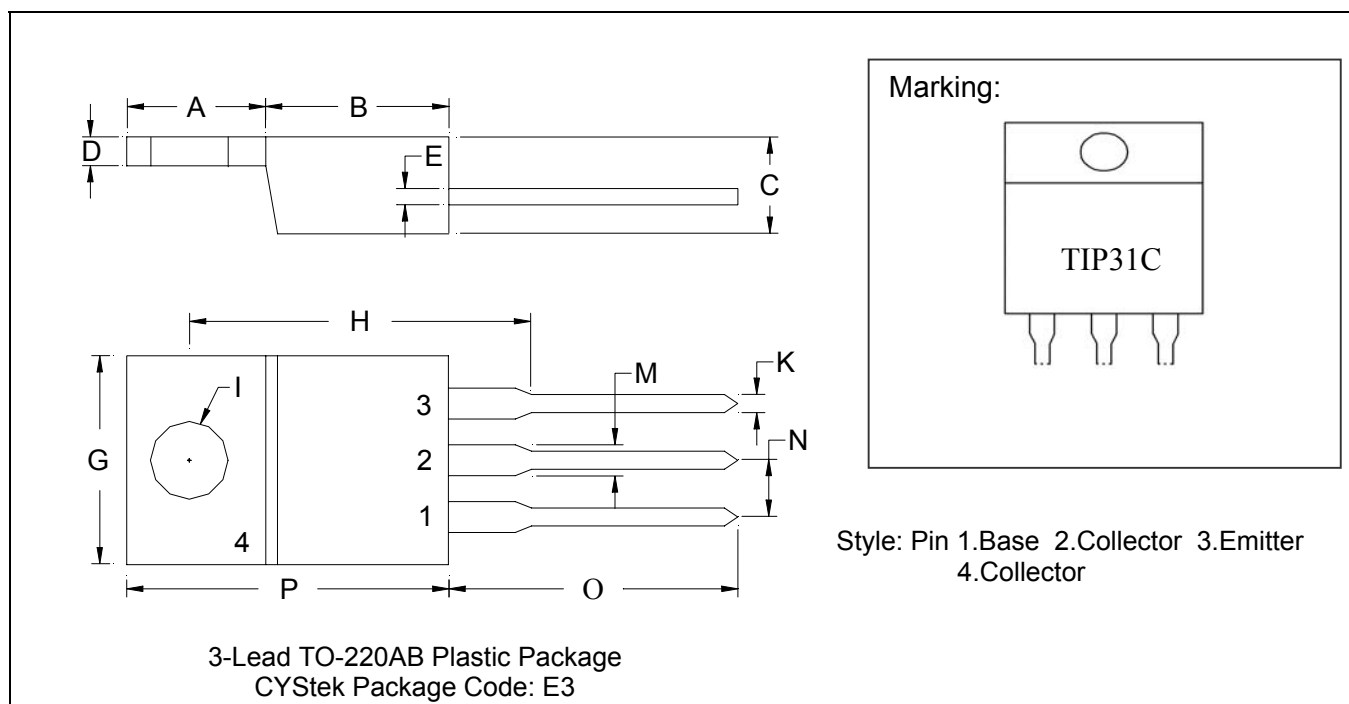
Power Derating Curve



Power Derating Curve



TO-220AB Dimension



*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.2197	0.2949	5.58	7.49	I	-	*0.1508	-	*3.83
B	0.3299	0.3504	8.38	8.90	K	0.0295	0.0374	0.75	0.95
C	0.1732	0.185	4.40	4.70	M	0.0449	0.0551	1.14	1.40
D	0.0453	0.0547	1.15	1.39	N	-	*0.1000	-	*2.54
E	0.0138	0.0236	0.35	0.60	O	0.5000	0.5618	12.70	14.27
G	0.3803	0.4047	9.66	10.28	P	0.5701	0.6248	14.48	15.87
H	-	*0.6398	-	*16.25					

Notes: 1. Controlling dimension: millimeters.

2. Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.

3. If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: 42 Alloy ; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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